



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Eric NEYRET et al.

Confirmation No. 6832

Application No.: 10/671,813

Group Art Unit: 2814

Filing Date: September 25, 2003

Examiner: Dilinh P. Nguyen

For: METHOD FOR MINIMIZING SLIP LINE
FAULTS ON A SEMICONDUCTOR
WAFER SURFACE

Attorney Docket No.: 4717-7800

AMENDMENT

Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, Virginia 22313-1450

Sir:

In response to the final office action dated March 9, 2006, please enter the following amendments and comments into the file of this application.

Amendments to the Claims are reflected in the complete listing of all claims which begin on page 2 of this paper.

Amendments to the Drawings begin on page 6 of this paper and replacement drawing sheets are attached hereto.

Remarks begin on page 7 of this paper.

A **Petition for Extension of Time** for a one (1) month extension is also enclosed herewith.

No fee is believed to be due for this response. Please charge any required fees to Winston Strawn LLP Deposit Account No. 50-1814.